

LP3943 16-Channel RGB, White-LED Driver with Independent SMBUS/I²C String Control

1 Features

- Internal power-on reset
- Active low reset
- Internal precision oscillator
- Variable dim rates (from 6.25ms to 1.6s; 160Hz to 0.625Hz)
- 16 LED drivers (multiple programmable states: ON, OFF, input, and dimming at a specified rate)
- 16 open-drain outputs capable of driving up to 25mA per LED

2 Applications

- Customized flashing LED lights for cellular phones
- Portable applications
- Digital cameras
- Indicator lamps
- General purpose I/O expander

3 Description

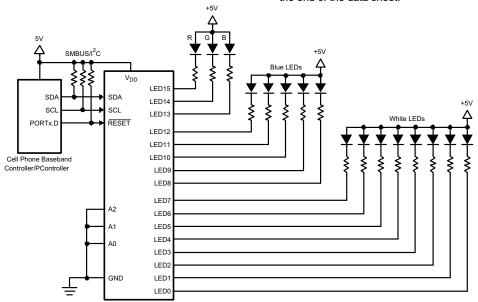
The LP3943 is an integrated device capable of independently driving 16 LEDs. This device also contains an internal precision oscillator that provides all the necessary timing required for driving each LED. Two prescaler registers, along with two PWM registers, provide a versatile duty-cycle control. The LP3943 contains the ability to dim LEDs in SMBUS/I²C applications where it is required, to cut down on bus traffic.

Traditionally, dimming LEDs using a serial shift register such as 74LS594/5 requires a large amount of traffic on the serial bus. The LP3943 instead requires only the setup of the frequency and duty cycle for each output pin; from then on, only a single command from the host is required to turn each individual open drain output to an ON or OFF state, or to cycle a programmed frequency and duty cycle. Maximum output sink current is 25mA per pin and 200mA per package. Any ports not used for controlling the LEDs can be used for general purpose input/output expansion.

Device Information (1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
LP3943	WQFN (24)	4.00mm × 4.00mm		

For all available packages, see the orderable addendum at the end of the data sheet.



Typical Application Circuit



Table of Contents

1 Features1	5.7 Typical Characteristic6
2 Applications1	6 Detailed Description
3 Description1	6.1 Overview
4 Pin Configuration and Functions2	6.2 Functional Block Diagram
Pin Functions2	6.3 Feature Description
5 Specifications4	6.4 Device Functional Modes
5.1 Absolute Maximum Ratings4	6.5 Programming9
5.2 ESD Ratings4	6.6 Register Maps12
5.3 Recommended Operating Conditions4	7 Device and Documentation Support19
5.4 Thermal Information4	7.1 Receiving Notification of Documentation Updates19
5.5 Electrical Characteristics5	7.2 Community Resources19
5.6 I ² C Interface (SCL and SDA Pins) Timing	7.3 Trademarks19
Requirements6	8 Revision History19

4 Pin Configuration and Functions

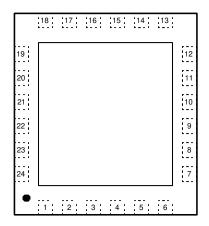


Figure 4-1. RTW Package 24-Pin WQFN With Exposed Pad Top View

Pin Functions

P	PIN I/O		DESCRIPTION		
NUMBER	NAME	1/0	DESCRIPTION		
1	LED0	Output	Output of LED0 Driver		
2	LED1	Output	Output of LED1 Driver		
3	LED2	Output	Output of LED2 Driver		
4	LED3	Output	Output of LED3 Driver		
5	LED4	Output	Output of LED4 Driver		
6	LED5	Output	Output of LED5 Driver		
7	LED6	Output	Output of LED6 Driver		
8	LED7	Output	Output of LED7 Driver		
9	GND	Ground	Ground		
10	LED8	Output	Output of LED8 Driver		
11	LED9	Output	Output of LED9 Driver		
12	LED10	Output	Output of LED10 Driver		
13	LED11	Output	Output of LED11 Driver		

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated



www.ti.com

F	PIN		DESCRIPTION		
NUMBER	NAME	I/O	DESCRIPTION		
14	LED12	Output	Output of LED12 Driver		
15	LED13	Output	Output of LED13 Driver		
16	LED14	Output	Output of LED14 Driver		
17	LED15	Output	Output of LED15 Driver		
18	RST	Input	Active Low Reset Input		
19	SCL	Input	Clock Line for I ² C Interface		
20	SDA	Input/Output	Serial Data Line for I ² C Interface		
21	VDD	Power	Power Supply		
22	A0	Input	Address Input 0		
23	A1	Input	Address Input 1		
24	A2	Input	Address Input 2		
_	Exposed Pad	_	Tie internally to GND pin.		



5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1) (2) (3)

	MIN	MAX	UNIT
V_{DD}	-0.5	6	V
A0, A1, A2, SCL, SDA, RST (Collectively called digital pins)		6	V
Voltage on LED pins	V _{SS} - 0.5	6	V
Junction temperature		150	°C
Power dissipation ⁽⁴⁾		400	mW
Storage temperature	-65	150	°C

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Section 5.3. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to the potential at the GND pin.
- (3) If Military/Aerospace specified devices are required, contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (4) The part cannot dissipate more than 400 mW.

5.2 ESD Ratings

			VALUE	UNIT
		Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	
V _(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1000	v
	•	Machine model	±200	

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1) (2)

	MIN	NOM MAX	UNIT
V_{DD}	2.3	5.5	V
Junction temperature	-40	125	°C
Operating ambient temperature	-40	85	°C

- (1) Absolute Maximum Ratings are limits beyond which damage to the device might occur. Recommended Operating Conditions are conditions under which operation of the device is ensured. Recommended Operating Conditions do not imply ensured performance limits. For verified performance limits and associated test conditions, see Section 5.5.
- (2) All voltages are with respect to the potential at the GND pin.

5.4 Thermal Information

		LP3943		
	THERMAL METRIC ⁽¹⁾	RTW (WQFN)	UNIT	
		24 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance	45.0	°C/W	
R _{0JC(top)}	Junction-to-case (top) thermal resistance	41.5	°C/W	
R _{0JB}	Junction-to-board thermal resistance	22.4	°C/W	
Ψлт	Junction-to-top characterization parameter	0.5	°C/W	
ΨЈВ	Junction-to-board characterization parameter	22.5	°C/W	
R _{0JC(bot)}	Junction-to-case (bottom) thermal resistance	3.7	°C/W	

(1) For more information about traditional and new thermal metrics, see Semiconductor and IC Package Thermal Metrics.

Product Folder Links: LP3943



5.5 Electrical Characteristics

Unless otherwise noted, V_{DD} = 5.5V. Typical values and limits apply for T_J = 25°C. Minimum and maximum limits apply over the entire junction temperature range for operation, T_J = -40°C to +125°C. (1)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
POWER SI	UPPLY				<u> </u>		
V _{DD}	Supply voltage		2.3	5	5.5	V	
IQ	Supply current	No load		350	550		
		Standby		2	5	μA	
ΔI_Q	Additional standby current	V _{DD} = 5.5V, every LED pin at 4.3V			2	mA	
V _{POR}	Power-On Reset voltage			1.8	1.96	V	
t _w	Reset pulse width			10		ns	
LED							
V _{IL}	Low level input voltage		-0.5		0.8	V	
V _{IH}	High level input voltage		2		5.5	V	
		V _{OL} = 0.4V, V _{DD} = 2.3V	9				
	Low level output current ⁽²⁾	$V_{OL} = 0.4V, V_{DD} = 3V$	12			mA	
		$V_{OL} = 0.4V, V_{DD} = 5V$	15				
l _{OL}		$V_{OL} = 0.7V, V_{DD} = 2.3V$	15				
		$V_{OL} = 0.7V, V_{DD} = 3V$	20				
		$V_{OL} = 0.7V, V_{DD} = 5V$	25				
I _{LEAK}	Input leakage current	V_{DD} = 3.6V, V_{IN} = 0V or V_{DD}	-1		1	μA	
C _{I/O}	Input/output capacitance	See ⁽³⁾		2.6	5	pF	
ALL DIGIT	AL PINS (EXCEPT SCL AND SDA	A PINS)					
V _{IL}	LOW level input voltage		-0.5		0.8	V	
V _{IH}	HIGH level input voltage		2		5.5	V	
I _{LEAK}	Input leakage current		-1		1	μA	
C _{IN}	Input capacitance	$V_{IN} = 0V^{(3)}$		2.3	5	pF	
I ² C INTER	FACE (SCL AND SDA PINS)						
V _{IL}	LOW level input voltage		-0.5		0.3V _{DD}	V	
V _{IH}	HIGH level input voltage		0.7V _{DD}		5.5	V	
V _{OL}	LOW level output voltage		0		0.2V _{DD}	V	
I _{OL}	LOW level output current	V _{OL} = 0.4V	V _{OL} = 0.4V 3 6.5			mA	
I _{Q_SCL/SDA}	SCL/SDA to VDD capable current			100		μΑ	
f_{CLK}	Clock frequency				400	kHz	

⁽¹⁾ Limits are ensured. All electrical characteristics having room-temperature limits are tested during production with T_J = 25°C. All hot and cold limits are ensured by correlating the electrical characteristics to process and temperature variations and applying statistical process control.

⁽²⁾ Each LED pin must not exceed 25 mA and each octal (LED0-LED7; LED8-LED15) must not exceed 100 mA. The package must not exceed a total of 200 mA.

⁽³⁾ Verified by design.



5.6 I²C Interface (SCL and SDA Pins) Timing Requirements

See⁽¹⁾

		MIN	NOM	MAX	UNIT
t _{HOLD}	Hold time repeated START condition	0.6			μs
t _{CLK-LP}	CLK low period	1.3			μs
t _{CLK-HP}	CLK high period	0.6			μs
t _{SU}	Setup time repeated START condition	0.6			μs
t _{DATA-HOLD}	Data hold time	300			ns
t _{DATA-SU}	Data setup time	100			ns
t _{SU}	Setup time for STOP condition	0.6			μs
t _{TRANS}	Maximum pulse width of spikes that must be suppressed by the input filter of both DATA and CLK signals		50		ns

(1) All values verified by design.

5.7 Typical Characteristic

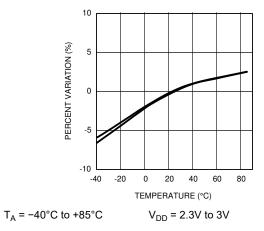


Figure 5-1. Frequency vs. Temperature

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated

6 Detailed Description

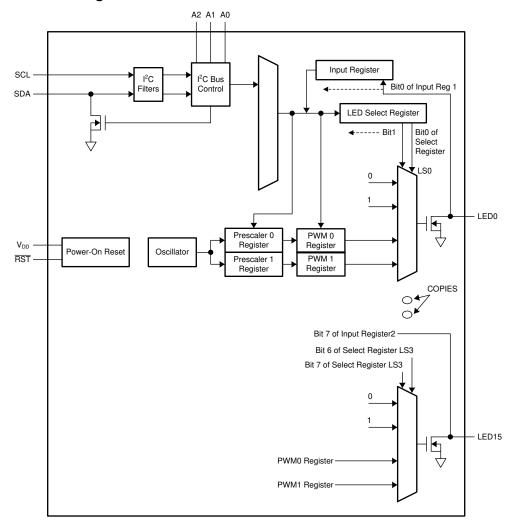
6.1 Overview

The LP3943 takes incoming data from the baseband controller and feeds them into several registers that control the frequency and the duty cycle of the LEDs. Two prescaler registers and two PWM registers provide two individual rates to dim or blink the LEDs (for more information on these registers, refer to Table 6-1). Each LED can be programmed in one of four states: ON, OFF, DIM0 rate, or DIM1 rate. Two read-only registers provide status on all 16 LEDs. The LP3943 can be used to drive RGB LEDs and/or single-color LEDs to create a colorful, entertaining, and informative setting. Alternatively, it can also drive RGB LED as a flashlight. This is particularly suitable for accessory functions in cellular phones and toys. Any LED pins not used to drive LED can be used for general purpose parallel input/output (GPIO) expansion.

The LP3943 is equipped with power-on reset that holds the chip in a reset state until V_{DD} reaches V_{POR} during power up. Once V_{POR} is achieved, the LP3943 comes out of reset and initializes itself to the default state.

To bring the LP3943 into reset, hold the \overline{RST} pin LOW for a period of TW. This puts the chip into its default state. The LP3943 can only be programmed after \overline{RST} signal is HIGH again.

6.2 Functional Block Diagram



Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback



6.3 Feature Description

Some of the features of the LP3943 device are:

- 1. 16 low-side switches to control the current in 16 strings of LEDs with a maximum of 25mA per switch or a maximum of 200mA total.
- 2. Programmable internal PWM dimming:
 - a. Duty cycle control (8 bits). Any of the 16 current switches can be mapped to either PWM0 register or PWM1 register. Each register offers 8-bit PWM duty cycle control.
 - b. PWM Frequency control (8 bits). Any of the 16 current switches can be mapped to either PSC0 register or PSC1 register. Each register offers 8-bit PWM frequency control from 0.625Hz to 160Hz.
- 3. RESET input.
- 4. Auto increment for I2C writes to reduce number of I2C clock pulses .
- 5. The LP3943 provides for an externally selectable I2C slave address via the ADR0, ADR1, and ADR2 inputs. See Figure 6-3.

6.4 Device Functional Modes

- 1. Output set to high impedance. This is set by programming bits [B0 and B1] to 00 in the LS0, LS1, LS2, or LS3 registers (see Table 2)
- 2. Output set to ON state (current switch pulls low). This turns the LED on at the full current in the specified current switch bits [B0 and B1] set to 01 in the LS0, LS1, LS2, or LS3 registers (see Table 6-12).
- 3. Output set to toggle at the programmed PWM duty cycle and PWM frequency. This turns on or off the specified current switch at the programmed PWM frequency and duty cycle. Each current switch is mapped to either of the PWM0/PSC0 or PWM1/PSC1 pairs by setting [B0 and B1] to 10 or 11 in the LS0, LS1, LS2, or LS3 registers (see Table 6-12).

Product Folder Links: LP3943

6.5 Programming

6.5.1 I²C Data Validity

The data on SDA line must be stable during the HIGH period of the clock signal (SCL). In other words, state of the data line can only be changed when CLK is LOW.

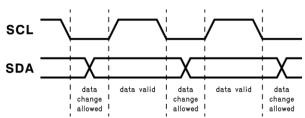


Figure 6-1. I²C Data Validity

6.5.2 I²C START and STOP Conditions

START and STOP bits classify the beginning and the end of the I²C session. START condition is defined as SDA signal transitioning from HIGH to LOW while SCL line is HIGH. STOP condition is defined as the SDA transitioning from LOW to HIGH while SCL is HIGH. The I²C master always generates START and STOP bits. The I²C bus is considered to be busy after START condition and free after STOP condition. During data transmission, I²C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.

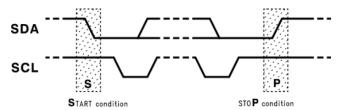


Figure 6-2. I²C START and STOP Conditions

6.5.3 Transferring Data

Every byte put on the SDA line must be eight bits long with the most significant bit (MSB) being transferred first. The number of bytes that can be transmitted per transfer is unrestricted. Each byte of data has to be followed by an acknowledge bit. The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the 9th clock pulse, signifying an acknowledge. A receiver which has been addressed must generate an acknowledge after each byte has been received.

After the START condition, a chip address is sent by the I²C master. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). The LP3943 hardwires bits 7 to 4 and leaves bits 3 to 1 selectable, as shown in Figure 6-3. For the eighth bit, a 0 indicates a WRITE and a 1 indicates a READ. The LP3943 supports only a WRITE during chip addressing. The second byte selects the register to which the data is written. The third byte contains data to write to the selected register.

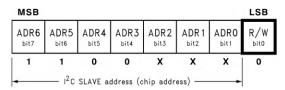
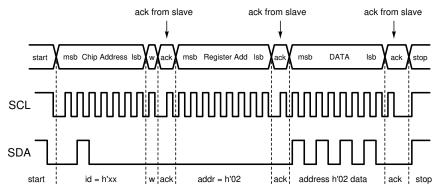


Figure 6-3. Chip Address Byte

Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback

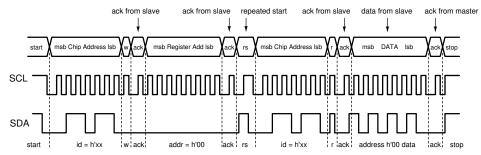




w = write (SDA = 0) r = read (SDA = 1) ack = acknowledge (SDA pulled LOW by either master or slave) rs = repeated start xx = 60 to 67

Figure 6-4. LP3943 Register Write

However, if a READ function is to be accomplished, a WRITE function must precede the READ function, as shown in Figure 6-5.



w = write (SDA = "0") r = read (SDA = "1") ack = acknowledge (SDA pulled LOW by either master or slave) rs = repeated start xx = 60 to 67

Figure 6-5. LP3943 Register Read

6.5.4 Auto Increment

Auto increment is a special feature supported by the LP3943 to eliminate repeated chip and register addressing when data are to be written to or read from registers in sequential order. The auto increment bit is inside the register address byte, as shown in Figure 6-6. Auto increment is enabled when this bit is programmed to "1" and disabled when it is programmed to "0".

Bits 5, 6 and 7 in the register address byte must always be zero.

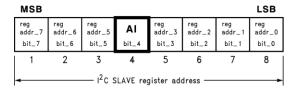


Figure 6-6. Register Address Byte

In the READ mode, when auto increment is enabled, I²C master could receive any number of bytes from LP3943 without selecting chip address and register address again. Every time the I²C master reads a register, the LP3943 increments the register address, and the next data register is read. When I²C master reaches the last register (09H), the register address rolls over to 00H.

In the WRITE mode, when auto increment is enabled, the LP3943 increments the register address every time I²C master writes to register. When the last register (09H register) is reached, the register address rolls over to 02H, not 00H, because the first two registers in LP3943 are read-only registers. It is possible to write to the first two registers independently, and the LP3943 device will acknowledge, but the data is ignored.

Product Folder Links: LP3943



If auto increment is disabled, and the I^2C master does not change register address, it continues to write data into the same register.

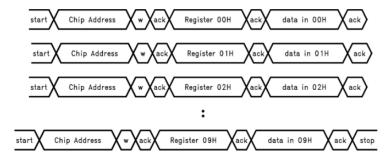


Figure 6-7. Programming With Auto Increment Disabled (in WRITE Mode)

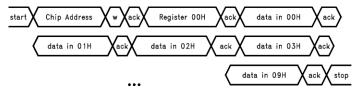


Figure 6-8. Programming With Auto Increment Enabled (in WRITE Mode)

Default value

Default value

12

Х

LED15

Χ

LED14



6.6 Register Maps

Table 6-1. LP3943 Register Table

Address (Hex)	Register Name	Read/Write	Register Function
0x00	Input 1	Read Only	LED0–7 Input Register
0x01	Input 2	Read Only	LED8–15 Input Register
0x02	PSC0	R/W	Frequency Prescaler 0
0x03	PWM0	R/W	PWM Register 0
0x04	PSC1	R/W	Frequency Prescaler 1
0x05	PWM1	R/W	PWM Register 1
0x06	LS0	R/W	LED0-3 Selector
0x07	LS1	R/W	LED4-7 Selector
0x08	0x08 LS2 R/W LED8-11 Selecto		LED8–11 Selector
0x09	LS3	R/W	LED12–15 Selector

6.6.1 Binary Format for Input Registers (Read-only)—Address 0x00 and 0x01

Table 6-2. Address 0x00

Bit #	7	6	5	4	3	2	1	0	
Default value	Х	Х	Х	Х	Х	Х	X	Х	
	LED7	LED6	LED5	LED4	LED3	LED2	LED1	LED0	
Table 6-3. Address 0x01									
Bit #	7	6	5	4	3	2	1	0	

Х

LED12

Х

LED11

Χ

LED10

Χ

LED9

Χ

LED8

6.6.2 Binary Format for Frequency Prescaler and PWM Registers — Address 0x02 to 0x05

Х

LED13

Table 6-4. Address 0x02 (PSC0)

Table 0-4. Address 0x02 (F3C0)											
Bit #	7	6	5	4	3	2	1	0			
Default value	0	0	0	0	0	0	0	0			
Table 6-5. Address 0x03 (PWM0)											
Bit #	7	6	5	4	3	2	1	0			
Default value	1	0	0	0	0 0		0	0			
			Table 6-6.	Address 0x	04 (PSC1)						
Bit #	7	6	5	4	3	2	1	0			
Default value	0	0	0	0	0	0	0	0			
Table 6-7. Address 0x05 (PWM1)											
Bit #	7	6	5	4	3	2	1	0			

Product Folder Links: LP3943

6.6.3 Binary Format for Selector Registers — Address 0x06 to 0x09

Table 6-8. Address 0x06 (LS0)

Bit #	7	6	5	4	3	2	1	0
Default value	0	0	0	0	0	0	0	0
	B1	В0	B1	В0	B1	В0	B1	В0
	LED3		LE	D2	LE	D1	LE	D0

Table 6-9. Address 0x07 (LS1)

Default value	0	0	0	0	0	0	0	0
	B1	B1 B0		В0	B1	В0	B1	В0
	LE	D7	LE	D6	LED5 L			D4

Table 6-10. Address 0x08 (LS2)

Bit #	7	6	5	4	3	2	1	0
Default value	0	0	0	0	0	0	0	0
	B1	В0	B1	В0	B1	В0	B1	В0
	LED11		LE	D10	LE	D9	LE	D8

Table 6-11. Address 0x09 (LS3)

Bit #	7	6	5	4	3	2	1	0
Default value	0	0	0	0	0	0	0	0
	B1	В0	B1	В0	B1 B0		B1 B0	
	LED15		LEI	D14	LEI	D13	LE	D12

Table 6-12. LED States With Respect To Values in B1 and B0

B1	В0	Function
0	0	Output Hi-Z (LED off)
0	1	Output LOW (LED on)
1	0	Output dims (DIM0 rate)
1	1	Output dims (DIM1 rate)



Programming Example:

- Dim LEDs 0 to 7 at 1Hz at 25% duty cycle
- Dim LEDs 8 to 12 at 5Hz at 50% duty cycle
- Set LEDs 13, 14 and 15 off
- Step 1: Set PSC0 to achieve DIM0 of 1 s
- Step 2: Set PWM0 duty cycle to 25%
- Step 3: Set PSC1 to achieve DIM1 of 0.2 s
- Step 4: Set PWM1 duty cycle to 50%
- Step 5: Set LEDs 13, 14 and 15 off by loading the data into LS3 register
- Step 6: Set LEDs 0 to 7 to point to DIM0
- Step 7: Set LEDs 8 to 12 to point to DIM1

Table 6-13. Programming Details

STEP	DESCRIPTION	REGISTER NAME	SET TO (HEX)
1	Set DIM0 = 1 s 1 = (PSC0 + 1)/160 PSC0 = 159	PSC0	0x09F
2	Set duty cycle to 25% Duty Cycle = PWM0/256 PWM0 = 64	PWM0	0x40
3	Set DIM1 = 0.2s 0.2 = (PSC1 + 1)/160 PSC1 = 31	PSC1	0x1F
4	Set duty cycle to 50% Duty Cycle = PWM1/256 PWM1 = 128	PWM1	0x80
5	LEDs 13, 14 and 15 off Output = HIGH	LS3	0x03
6	LEDs 0 to 7 Output = DIM0	LS0, LS1	LS0 = 0xAA LS1 = 0xAA
7	LEDs 8 to 12 Output = DIM1	LS2, LS3	LS2 = 0xFF LS3 = 0x03

Product Folder Links: *LP3943*

Copyright © 2024 Texas Instruments Incorporated

Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

1 Application Information

The LP3943 is a 16-channel LED controller which has 16 low-side current switches. Each switch can control the LED current in its respective LED or LEDs by modulating its duty cycle and frequency.

2 Typical Application

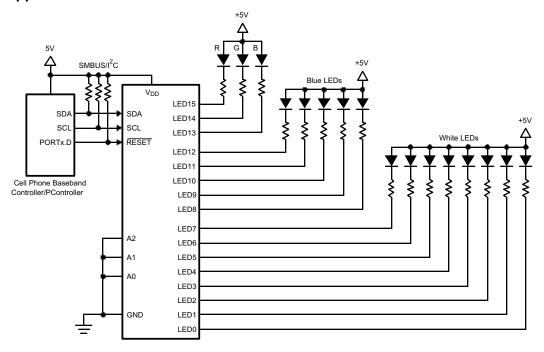


Figure 7-1. LP3943 Typical Application

2.1 Design Requirements

For typical RGB LED light-driver applications, use the parameters listed in Table 7-1.

Table 7-1. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
Minimum input voltage	2.3 V
Typical output voltage	5 V
Output current	20 mA

Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback

2.2 Detailed Design Procedure

2.2.1 Reducing I_Q When LEDs are OFF

In many applications, the LEDs and the LP3943 share the same V_{DD} , as shown in Figure 7-1. When the LEDs are off, the LED pins are at a lower potential than V_{DD} , causing extra supply current (ΔI_Q). To minimize this current, consider keeping the LED pins at a voltage equal to or greater than V_{DD} .

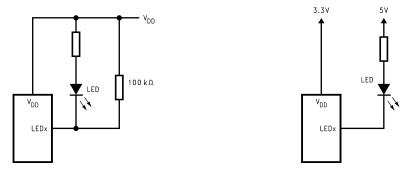


Figure 7-2. Methods to Reduce I_Q When LEDs are in OFF State

2.3 Application Curve

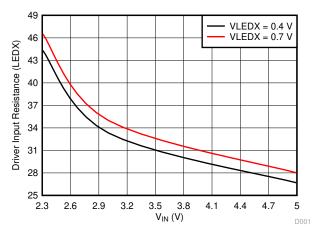


Figure 7-3. Typical LED Switch Resistance

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated



3 System Examples

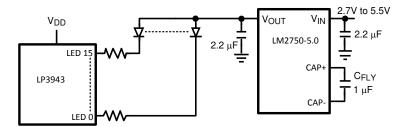


Figure 7-4. LP3943 With 5V Booster

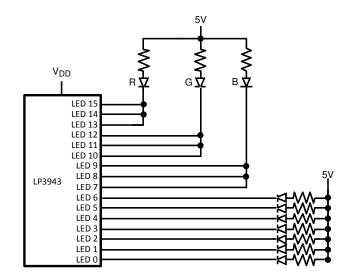


Figure 7-5. LP3943 Driving RGB LED as a Flash

4 Power Supply Recommendations

The LP3943 is designed to be powered from a 2.3V minimum to a 5.5V maximum supply input.

5 Layout

5.1 Layout Guidelines

The LP3943 layout is not critical, but TI recommends providing a noise-free supply input at V_{DD} . This typically would require a 1µF capacitor placed close to the VDD pin and ground.



5.2 Layout Example

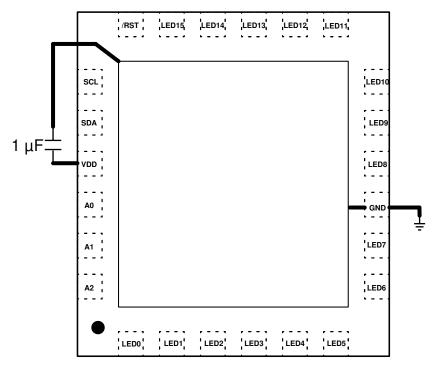


Figure 7-6. LP3943 Layout Example



7 Device and Documentation Support

7.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

7.2 Community Resources

7.3 Trademarks

All trademarks are the property of their respective owners.

8 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	hanges from Revision D (October 2016) to Revision E (October 2024)	Page
•	Added SCL/SDA to VDD capable current parameter to the Electrical Characteristics table	4
С	hanges from Revision C (October 2015) to Revision D (October 2016)	Page
•	Changed change wording of title to add SEO keywords	1
•	Changed R _{0JA} value from "37°C/W" to "45.0°C/W"; add additional thermal values	
С	hanges from Revision B (September 2013) to Revision C (October 2015)	Page
_	hanges from Pavisian B (Santambar 2012) to Pavisian C (October 2015)	Dogo
<u>c</u>	hanges from Revision B (September 2013) to Revision C (October 2015) Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature	Page
<u>c</u>		
<u>c</u>	Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation	ons,
<u>c</u>	Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information	ons,
•	Added Device Information and Pin Configuration and Functions sections, ESD Ratings table, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendation Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information	ons,

Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Copyright © 2024 Texas Instruments Incorporated

Product Folder Links: LP3943

www.ti.com 27-Sep-2024

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LP3943ISQ	OBSOLETE	WQFN	RTW	24		TBD	Call TI	Call TI	-40 to 85	3943SQ	
LP3943ISQ/NOPB	ACTIVE	WQFN	RTW	24	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	3943SQ	Samples
LP3943ISQX/NOPB	ACTIVE	WQFN	RTW	24	4500	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	3943SQ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.



PACKAGE OPTION ADDENDUM

www.ti.com 27-Sep-2024

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 25-Sep-2024

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP3943ISQ/NOPB	WQFN	RTW	24	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LP3943ISQX/NOPB	WQFN	RTW	24	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1



www.ti.com 25-Sep-2024



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP3943ISQ/NOPB	WQFN	RTW	24	1000	208.0	191.0	35.0
LP3943ISQX/NOPB	WQFN	RTW	24	4500	367.0	367.0	35.0

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025. Texas Instruments Incorporated